

# Glass micro bonding for the next generation smart implants **SCHOTT Primoceler**

Ultra reliable, miniaturized glass packages

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### **SCHOTT Primoceler: Who Are We?**

- Glass Micro Bonding specialist founded in 2010 and headquartered in Tampere, Finland
- Joined the SCHOTT family in August 2018
- Pioneering Technology: Unique additive-free, room temperature hermetic glass bonding
- Specializing in medical implants, microfluidics, microelectronics and micro-optics
- Mass production on-going with multimillion device production capacity





### **Next generation requirements**

More focus on information



Multiple functions for deeper understanding



Miniaturization for less invasion and closer to the treated area



RF Transparency for data transfer and collection



MRI compatibility

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### What Is Glass Wafer Micro Bonding?

- Wafer level hermetic bonding: high level of hermeticity
- Minimal heat load: heat-affected zone of just a few micrometers
- Additive-free: no adhesives or extra materials required
- Miniaturization: extremely small footprint thanks to simple material construction





### **Expanding the Limits of Conventional Hermetic Sealing**

Key benefits of Glass Micro Bonding



#### **Room Temperature**

- Enables coatings and other active layers
- Bio sensors



#### **Miniaturization**

- Minimal bonding / heat affected zone
- Low heat → less bulk, thinner materials
- Transparency enables RF transmission



#### **High Reliability**

- No adhesives 

   no outgassing
- Fully hermetic
- Medical implants



#### **Scalable Wafer-Level Process**

- Easily scale-up possible
- Many devices per wafer
- High yield



### **Unmatched Miniturization**

SCHOTT Primoceler all-glass packages come in sizes so small, you have to see it to believe it



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### **Enable Next-Generation Active Medical Implants**

With full-glass packages



#### **Room Temperature Process**

- Flexible assembly sequence
- Die and wafer level possibilities
- Suitable for coatings / sensitive components



#### **RF Transparency**

- Wireless power and data transfer
- Glass construction does not interfere with medical imaging process



#### **Biocompatibility**

- No additives or adhesives
- High hermeticity
- Cardio friendly: can also be used for heart pacers and neurostimulators





## Do you have any Questions?

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